



Eternal Semiconductor Inc.

ET120N08T

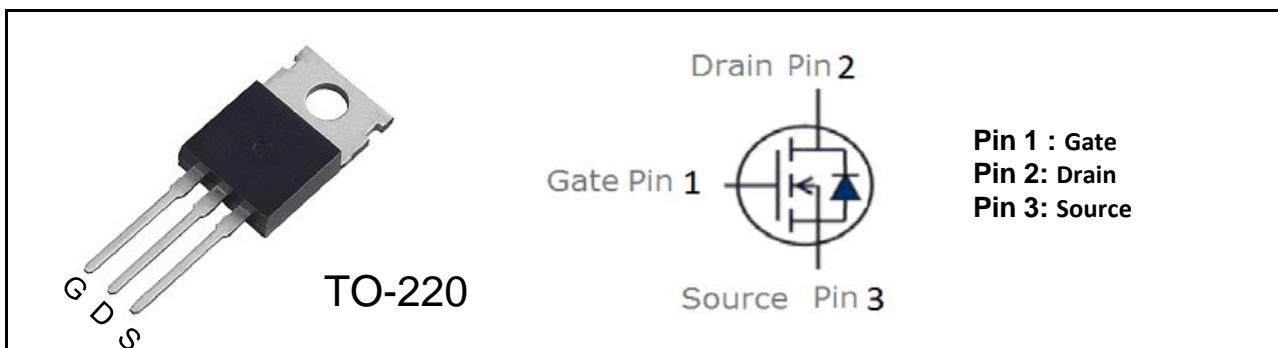
N-Channel Enhancement-Mode MOSFET (80V, 120A)

PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(on)}$ (mΩ) Typ
80	120	6.8@ $V_{GS} = 10V$, $I_D=40A$

Features

- Super high density cell design for extremely low RDS(ON)
- Exceptional on-resistance and maximum DC current capability
- 100% Avalanche test
- Lead (Pb) -free and halogen-free



Absolute Maximum Ratings ($T_A=25^\circ C$, unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	80	V
V_{GS}	Gate-Source Voltage	± 25	V
I_D	Drain Current (Continuous) @ $T_A=25^\circ C$	120	A
	Drain Current (Continuous) @ $T_A=75^\circ C$	90	A
I_{DM}	Drain Current (Pulsed) ^a	450	A
P_D	Total Power Dissipation @ $T_A=25^\circ C$	240	W
	Total Power Dissipation @ $T_A=75^\circ C$	120	W
E_{AS}	Avalanche Energy, Single Pulsed, $L=0.5mH$	620	mJ
I_S	Maximum Diode Forward Current	120	A
T_j, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +150	°C
R_{QJA}	Thermal Resistance Junction to Ambient (PCB mounted) ^b	62.5	°C/W

a: Repetitive Rating: Pulse width limited by the maximum junction temperature.

b: 1-in² 2oz Cu PCB board



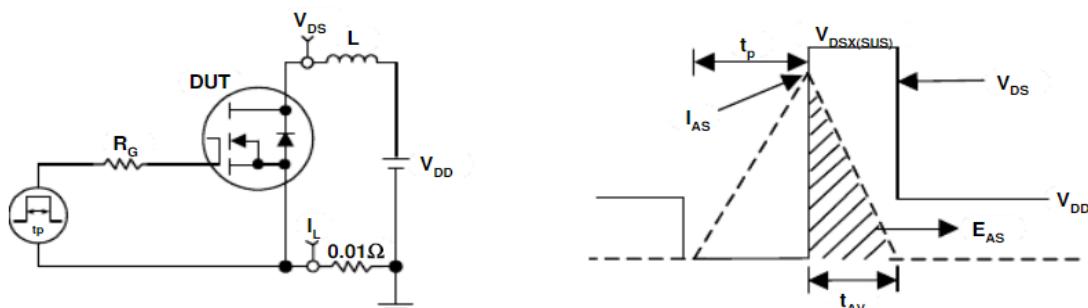
Eternal Semiconductor Inc.

ET120N08T

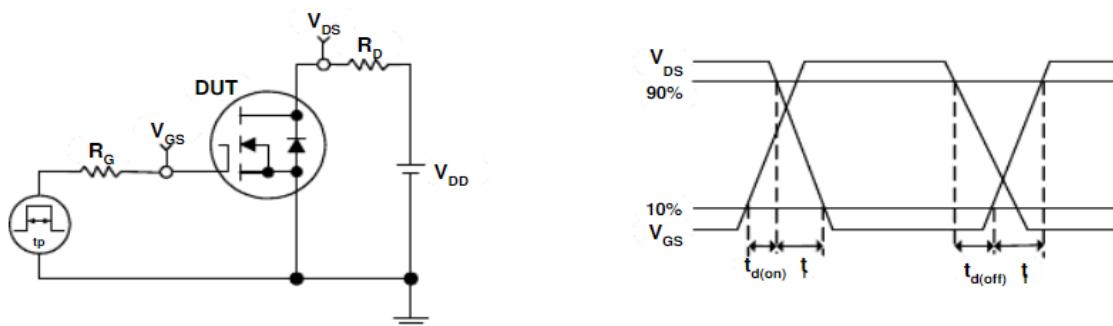
Electrical Characteristics ($T_A=25^\circ\text{C}$, unless otherwise noted)

Symbol	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
• Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	80	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=48\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 25\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
• On Characteristics						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0	3.0	4.0	V
$R_{\text{DS(on)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=40\text{A}$	-	5.5	6.5	$\text{m}\Omega$
• Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	7660	-	PF
C_{oss}	Output Capacitance		-	360	-	
C_{rss}	Reverse Transfer Capacitance		-	210	-	
• Switching Characteristics						
Q_g	Total Gate Charge	$V_{\text{DS}}=40\text{V}, I_{\text{D}}=30\text{A}, V_{\text{GS}}=10\text{V}$	-	145	-	nC
Q_{gs}	Gate-Source Charge		-	37	-	
Q_{gd}	Gate-Drain Charge		-	28	-	
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=30\text{V}, R_L=15\Omega, I_{\text{D}}=40\text{A}, V_{\text{GEN}}=10\text{V}, RG=6\Omega$	-	22	-	nS
t_r	Turn-on Rise Time		-	35	-	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	87	-	
t_f	Turn-off Fall Time		-	36	-	
• Drain-Source Diode Characteristics						
V_{SD}	Drain-Source Diode Forward	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=40\text{A}$	-	-	1.3	V

Note: Pulse Test: Pulse Width $\leq 300\text{us}$, Duty Cycle $\leq 2\%$



Avalanche Test Circuit and Waveforms



Avalanche Test Circuit and Waveforms



Eternal Semiconductor Inc.

ET120N08T

Typical Characteristics Curves (Ta=25°C, unless otherwise note)

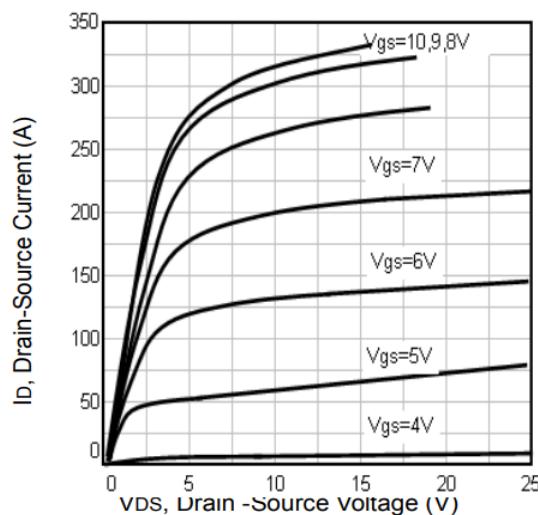


Fig1. Typical Output Characteristics

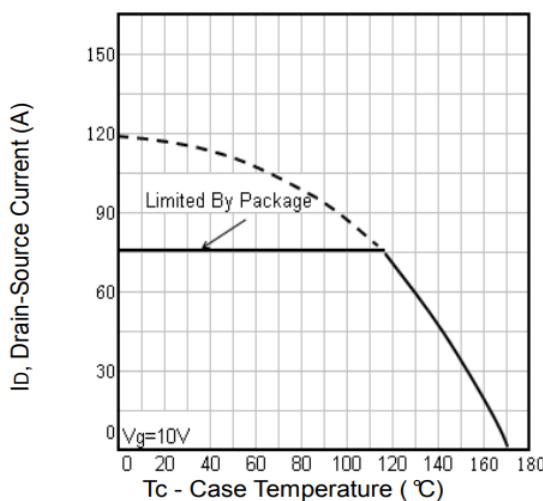


Fig2. Maximum Drain Current Vs. Case Temperature

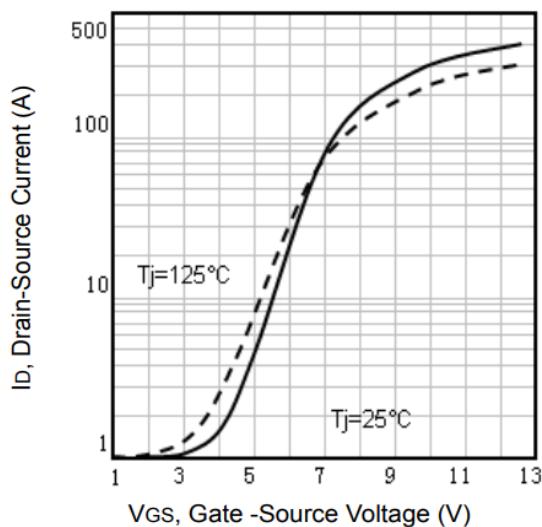


Fig3. Typical Transfer Characteristics

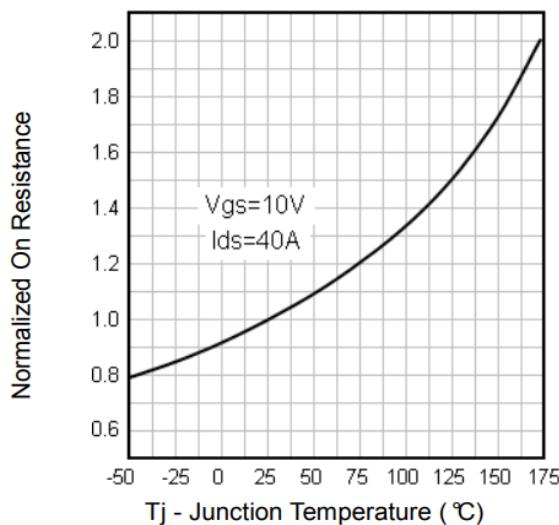


Fig4. Normalized On-Resistance Vs. Temperature

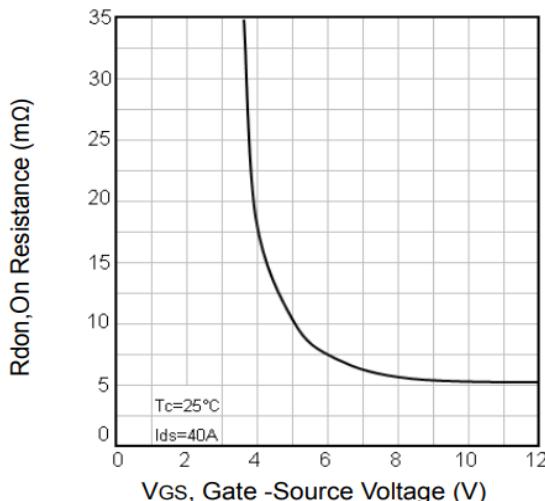


Fig5. Typical On-Resistance Vs. Gate-Source Voltage

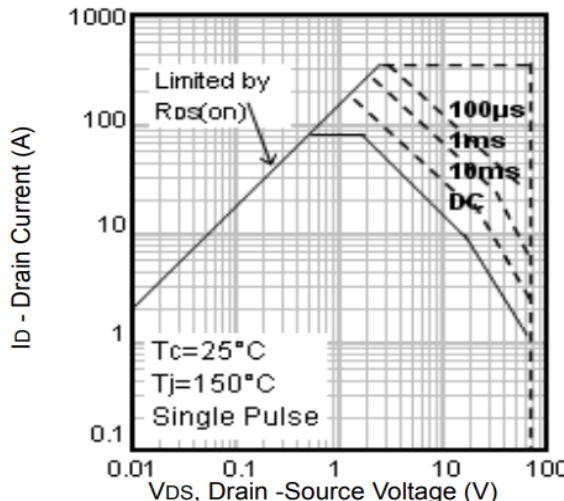


Fig6. Maximum Safe Operating Area

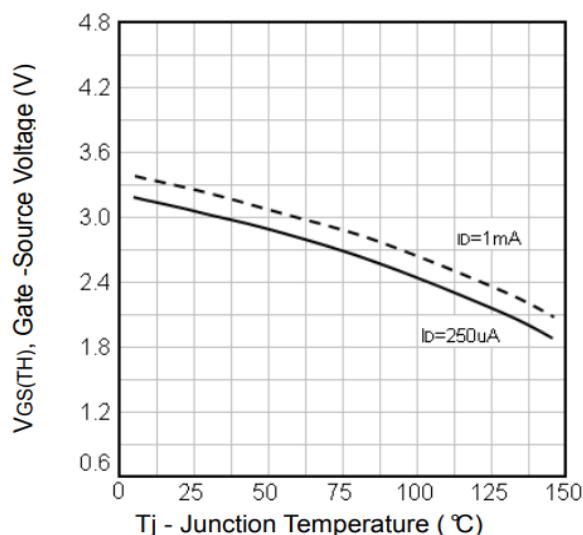


Fig7. Threshold Voltage Vs. Temperature

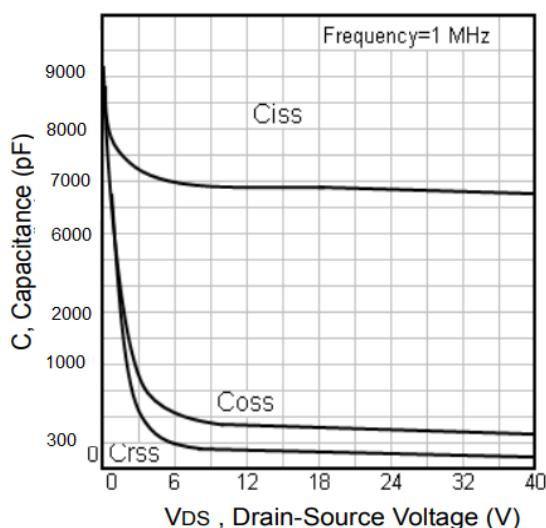


Fig8. Typical Capacitance Vs.Drain-Source Voltage

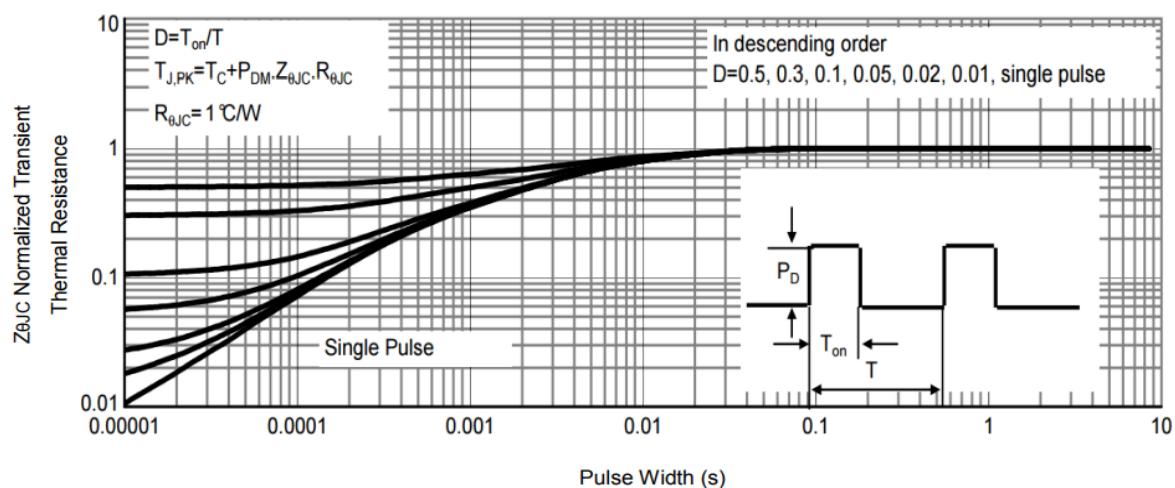


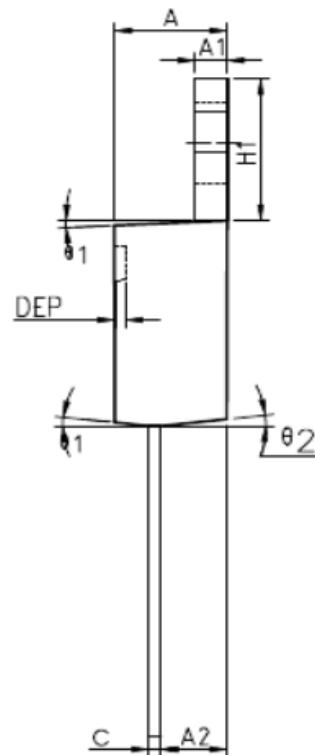
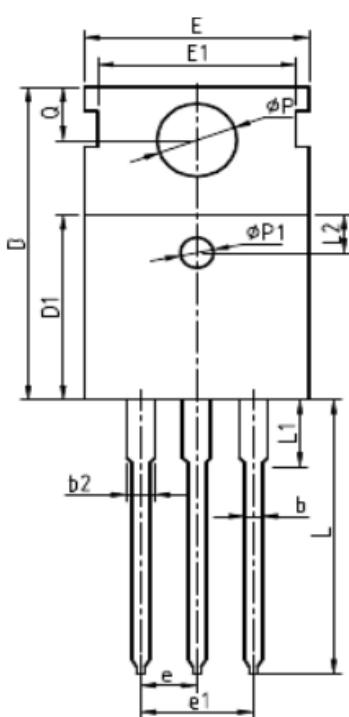
Fig9. Normalized Maximum Transient Thermal Impedance



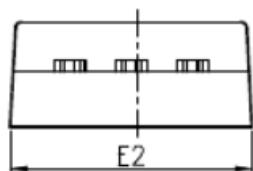
Eternal Semiconductor Inc.

ET120N08T

TO-220-3L PACKAGE OUTLINE DIMENSIONS



COMMON DIMENSIONS



SYMBOL	MIN	NOM	MAX	MIN	NOM	MAX
A	4.40	4.57	4.70	0.173	0.180	0.185
A1	1.27	1.30	1.33	0.050	0.051	0.052
A2	2.35	2.40	2.50	0.093	0.094	0.098
b	0.77	0.80	0.90	0.030	0.031	0.035
b2	1.17	1.27	1.36	0.046	0.050	0.054
c	0.48	0.50	0.56	0.019	0.020	0.022
D	15.40	15.60	15.80	0.606	0.614	0.622
D1	9.00	9.10	9.20	0.354	0.358	0.362
DEP	0.05	0.10	0.20	0.002	0.004	0.008
E	9.80	10.00	10.20	0.386	0.394	0.402
E1	-	8.70	-	-	0.343	-
E2	9.80	10.00	10.20	0.386	0.394	0.402
e		2.54	BSC		0.100	BSC
e1		5.08	BSC		0.200	BSC
H1	6.40	6.50	6.60	0.252	0.256	0.260
L	12.75	13.50	13.65	0.502	0.531	0.537
L1	-	3.10	3.30	-	0.122	0.130
L2		2.50	REF		0.098	REF
P	3.50	3.60	3.63	0.138	0.142	0.143
P1	3.50	3.60	3.63	0.138	0.142	0.143
Q	2.73	2.80	2.87	0.107	0.110	0.113
θ 1	5°	7°	9°	5°	7°	9°
θ 2	1°	3°	5°	1°	3°	5°
θ 3	1°	3°	5°	1°	3°	5°